

## XPT IGBT

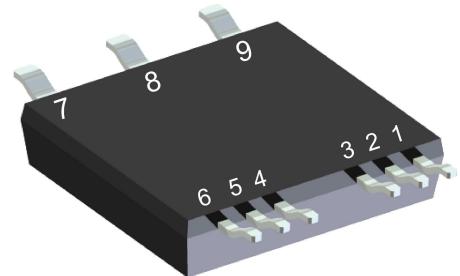
$V_{CES}$  = 1200 V  
 $I_{C25}$  = 32 A  
 $V_{CE(sat)}$  = 1.8 V

**ISOPLUS™ Surface Mount Power Device**  
**Boost Topology**  
**Boost/Brake Chopper + free wheeling diode + Vcesat-Diode**

**Part number**

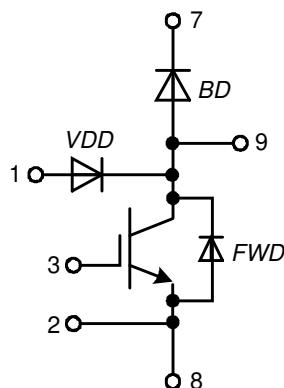
**IXA20RG1200DHGLB**

*Marking on Product: IXA20RG1200DHGLB*



Backside: isolated

 E72873



**Features / Advantages:**

- XPT IGBT
  - low saturation voltage
  - positive temperature coefficient for easy paralleling
  - fast switching
  - short tail current for optimized performance in resonant circuits
- Sonic™ diode
  - fast reverse recovery
  - low operating forward voltage
  - low leakage current
  - low temperature dependency of reverse recovery
- Vcesat detection diode (VDD)
  - integrated into package
  - very fast diode

**Applications:**

- AC drives
  - brake chopper
- PFC
  - boost chopper
- Switched reluctance drives

**Package: SMPD**

- Isolation Voltage: 3000 V~
- Industry convenient outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Soldering pins for PCB mounting
- Backside: DCB ceramic
- Reduced weight
- Advanced power cycling

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**Free Wheeling Diode FWD**

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$V_{RSM}$	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1200	V
$V_{RRM}$	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1200	V
$I_R$	reverse current, drain current * not applicable, see Ices at IGBT	$V_R = 1200 V$ $V_R = 1200 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		25 0.4	$\mu A$ mA
$V_F$	forward voltage drop	$I_F = 20 A$ $I_F = 40 A$ $I_F = 20 A$ $I_F = 40 A$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		2.20 2.20	V V
$I_{FAV}$	average forward current	$T_C = 80^\circ C$ rectangular $d = 0.5$	$T_{VJ} = 150^\circ C$		18	A
$V_{F0}$ $r_F$	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 150^\circ C$		1.29 41	V $m\Omega$
$R_{thJC}$	thermal resistance junction to case				1.35	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.40		K/W
$P_{tot}$	total power dissipation		$T_C = 25^\circ C$		93	W
$I_{FSM}$	max. forward surge current	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}; V_R = 0 V$	$T_{VJ} = 45^\circ C$		150	A
$C_J$	junction capacitance	$V_R = 400 V; f = 1 \text{ MHz}$	$T_{VJ} = 25^\circ C$	10		pF

**VCEsat Detection Diode VDD**

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$V_{RRM}$	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1200	V
$I_R$	reverse current, drain current	$V_{R/D} = 1200 V$ $V_{R/D} = 1200 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = +02^\circ C$		2 0.03	$\mu A$ mA
$V_F$	forward voltage drop	$I_F = 1 A$ $I_F = 1 A$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 12^\circ C$		2.20 1.80	V V
$V_{F0}$ $r_F$	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 150^\circ C$		1.30 390	V $m\Omega$
$C_J$	junction capacitance	$V_R = 400 V; f = 1 \text{ MHz}$	$T_{VJ} = 25^\circ C$	tbd		pF
$I_{RM}$	max. reverse recovery current		$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	2.3 tbd		A A
$t_{rr}$	reverse recovery time	$V_R = +02 V; I_F = 1 A$ $-di/dt = +02 A/\mu s$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	40 tbd		ns ns

**Boost IGBT**

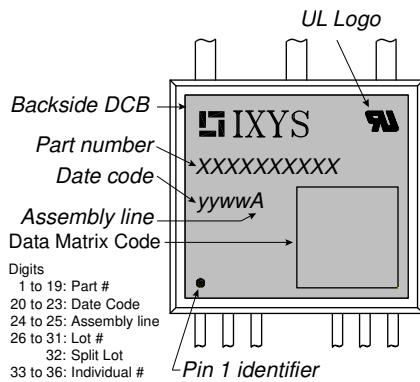
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^\circ C$			1200	V	
$V_{GES}$	max. DC gate voltage				$\pm 20$	V	
$V_{GEM}$	max. transient gate emitter voltage				$\pm 30$	V	
$I_{C25}$	collector current	$T_C = 25^\circ C$			32	A	
$I_{C80}$		$T_C = 80^\circ C$			23	A	
$P_{tot}$	total power dissipation	$T_C = 25^\circ C$			125	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 15 A; V_{GE} = 15 V$	$T_{VJ} = 25^\circ C$	1.8	2.1	V	
						V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.6 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ C$	5.4	5.9	6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$	0.1	0.1	mA	mA
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20 V$			500	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 V; V_{GE} = 15 V; I_C = 15 A$		48		nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600 V; I_C = 15 A$ $V_{GE} = \pm 15 V; R_G = 56 \Omega$	$T_{VJ} = 125^\circ C$	70		ns	
$t_r$	current rise time			40		ns	
$t_{d(off)}$	turn-off delay time			250		ns	
$t_f$	current fall time			100		ns	
$E_{on}$	turn-on energy per pulse			1.55		mJ	
$E_{off}$	turn-off energy per pulse			1.7		mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15 V; R_G = 56 \Omega$	$T_{VJ} = 125^\circ C$				
$I_{CM}$		$V_{CEmax} = 1200 V$			45	A	
<b>SCSOA</b>	short circuit safe operating area	$V_{CEmax} = 1200 V$					
$t_{sc}$	short circuit duration	$V_{CE} = 900 V; V_{GE} = \pm 15 V$	$T_{VJ} = 125^\circ C$		10	μs	
$I_{sc}$	short circuit current	$R_G = 56 \Omega$ ; non-repetitive		60		A	
$R_{thJC}$	thermal resistance junction to case				1	K/W	
$R_{thCH}$	thermal resistance case to heatsink			0.30		K/W	

**Boost Diode BD**

$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^\circ C$		1200	V
$I_{F25}$	forward current	$T_C = 25^\circ C$		27	A
$I_{F80}$		$T_C = 80^\circ C$		18	A
$V_F$	forward voltage	$I_F = 20 A$	$T_{VJ} = 25^\circ C$	2.20	V
			$T_{VJ} = 125^\circ C$		V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ C$	0.03	mA
			$T_{VJ} = 125^\circ C$		mA
$Q_{rr}$	reverse recovery charge	$V_R = 600 V$ $-di_F/dt = 400 A/\mu s$ $I_F = 20 A; V_{GE} = 0 V$	$T_{VJ} = 125^\circ C$	3	$\mu C$
				20	A
				350	ns
				0.7	mJ
$R_{thJC}$	thermal resistance junction to case			1.35	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.4	K/W

**Package SMPD**

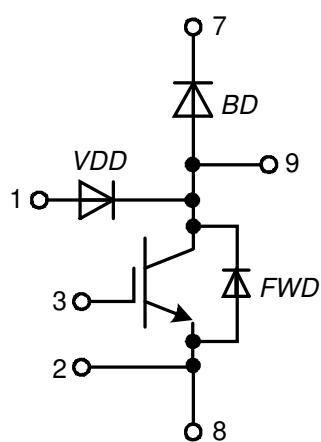
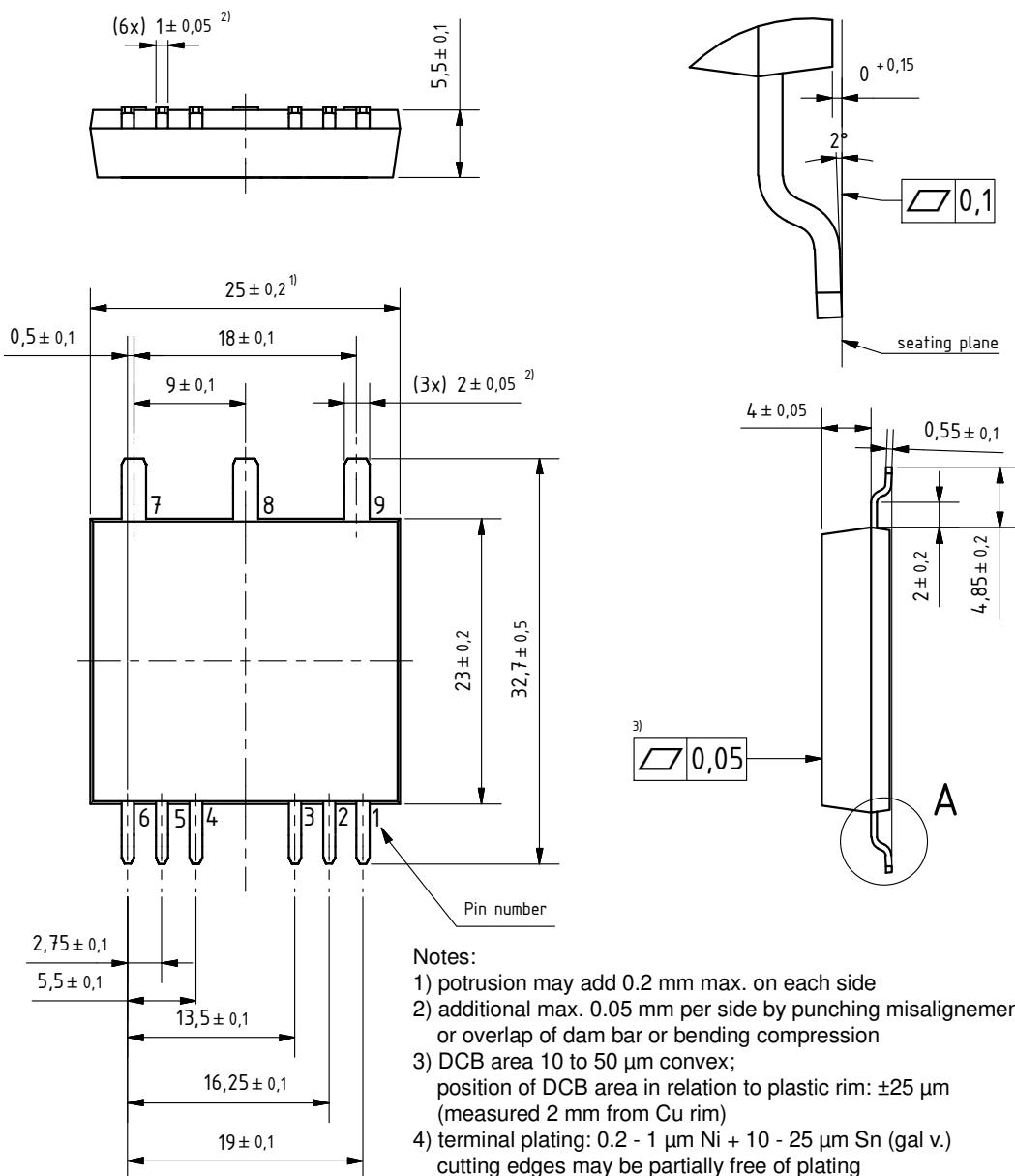
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$I_{RMS}$	RMS current	per terminal			100	A
$T_{VJ}$	virtual junction temperature		-55		150	°C
$T_{op}$	operation temperature		-55		125	°C
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				8.5		g
$F_c$	mounting force with clip		40		130	N
$d_{Spp/App}$	creepage distance on surface / striking distance through air	terminal to terminal	1.6			mm
$d_{Spb/Apb}$		terminal to backside	4.0			mm
$V_{ISOL}$	isolation voltage	t = 1 second t = 1 minute 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3000 2500			V


**Part description**

I = IGBT  
 X = XPT IGBT  
 A = Gen 1 / std  
 20 = Current Rating [A]  
 RG = Boost/Brake Chopper + free wheeling diode + Vcesat-Diode  
 1200 = Reverse Voltage [V]  
 D = Diode  
 H = Sonic Fast Recovery Diode  
 G = extreme fast  
 LB = SMPD-B

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	IXA20RG1200DHGLB-TUB	IXA20RG1200DHGLB	Tube	20	516134
Alternative	IXA20RG1200DHGLB-TRR	IXA20RG1200DHGLB	Tape & Reel	200	523508

Similar Part	Package	Voltage class
IXA30RG1200DHGLB	SMPD-B	1200
IXA40RG1200DHGLB	SMPD-B	1200

**Outlines SMPD**
**A ( 8 : 1 )**


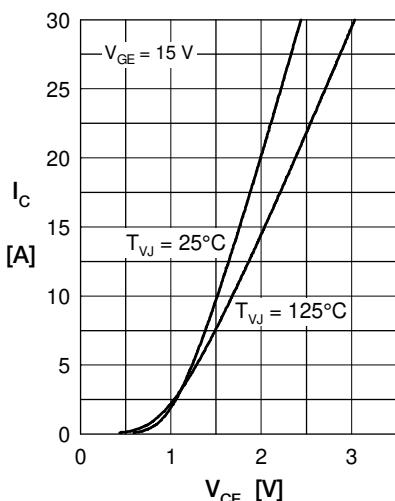
**Boost IGBT**


Fig. 1 Typ. output characteristics

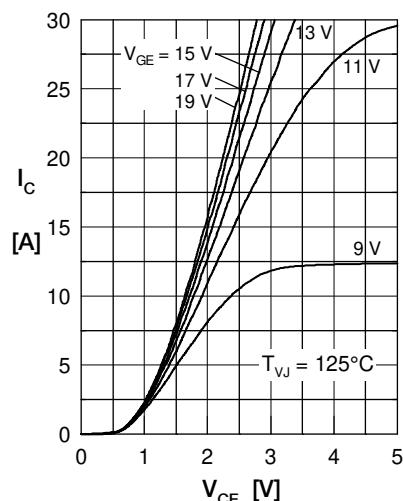


Fig. 2 Typ. output characteristics

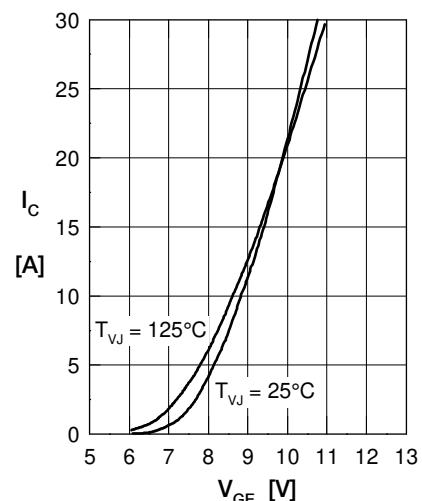


Fig. 3 Typ. tranfer characteristics

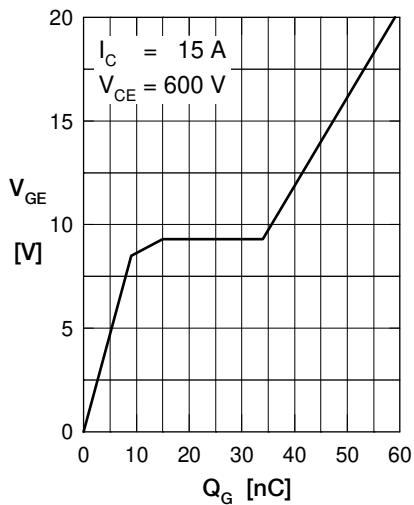


Fig. 4 Typ. turn-on gate charge

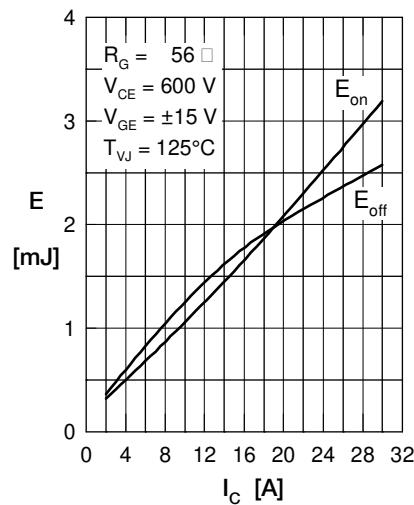


Fig. 5 Typ. switching energy versus collector current

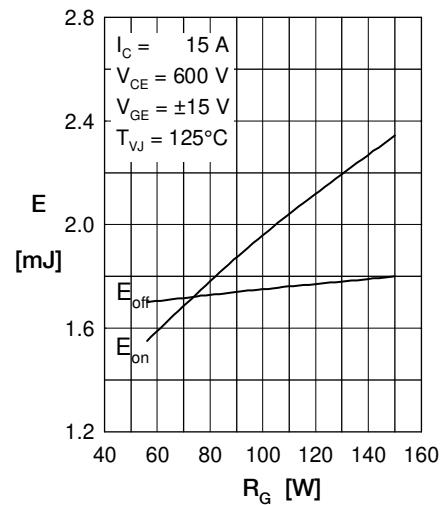


Fig. 6 Typ. switching energy versus gate resistance

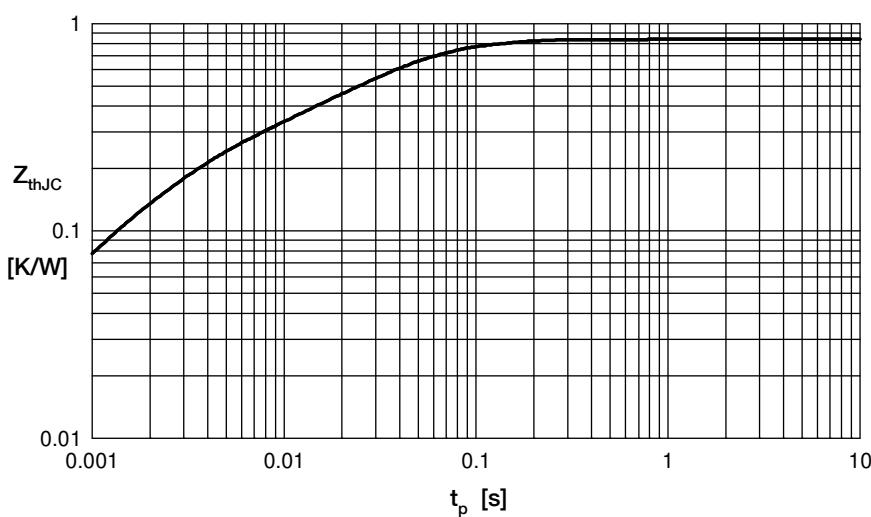


Fig. 7 Typ. transient thermal impedance junction to case

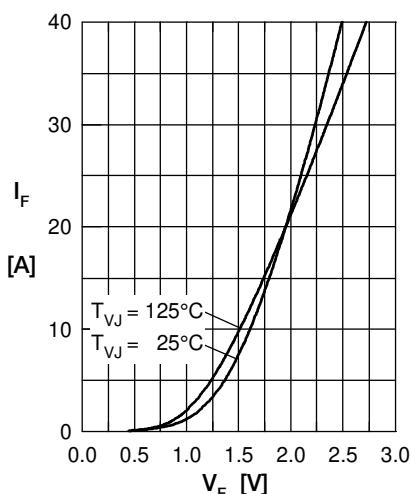
**Boost Diode BD**


Fig. 1 Typ. Forward current  
versus  $V_F$

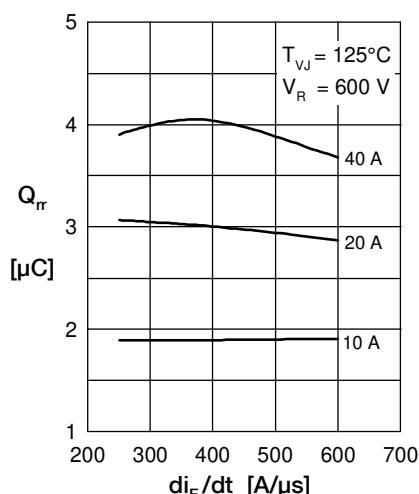


Fig. 2 Typ. reverse recov. charge  
 $Q_{rr}$  versus  $di/dt$

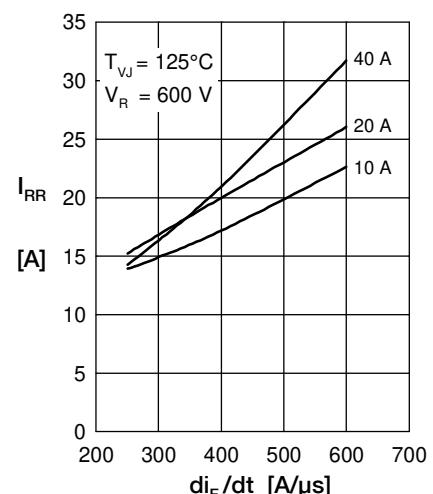


Fig. 3 Typ. peak reverse current  
 $I_{RM}$  versus  $di/dt$

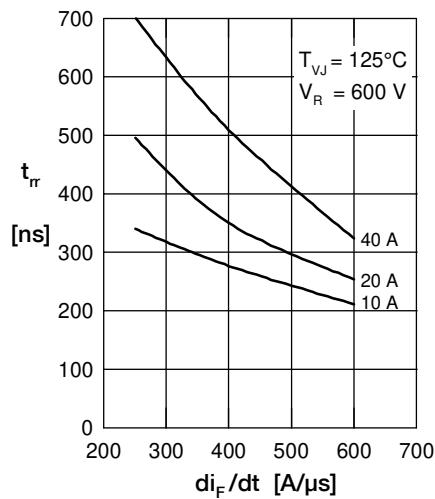


Fig. 4 Dynamic parameters  
 $Q_{rr}, I_{RM}$  versus  $di/dt$

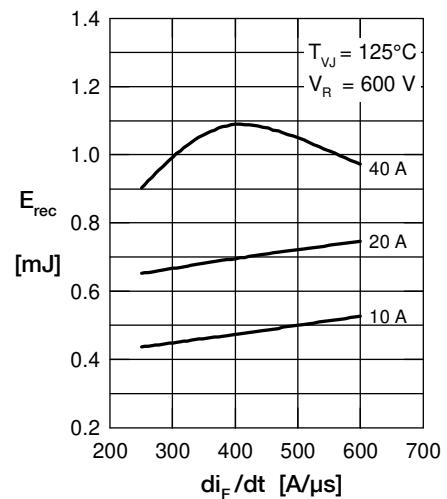


Fig. 6 Typ. recovery energy  
 $E_{rec}$  versus  $di/dt$

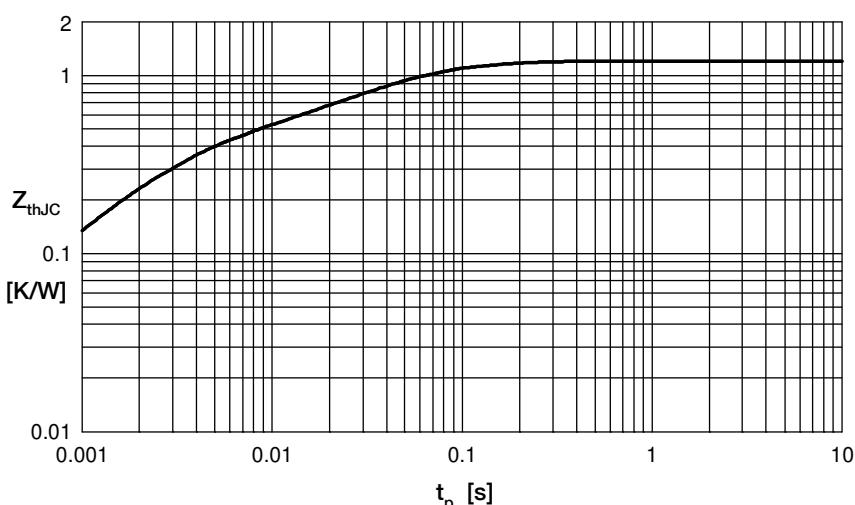


Fig. 7 Typ. transient thermal impedance junction to case